



30V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on)	I _D T _C = +25°C
30V	$0.95 \text{m}\Omega$ @ V _{GS} = 10V	130A
307	$1.5 \text{m}\Omega$ @ V _{GS} = 4.5V	111A

Description and Applications

This new generation MOSFET is designed to minimize $R_{DS(ON)}$ yet maintain superior switching performance. This device is ideal for use in notebook battery power managements and load switches.

- Body control electronics
- DC-DC converters

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses < 1.1mm Package Profile – Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH31M1LPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

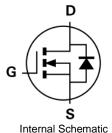
Mechanical Data

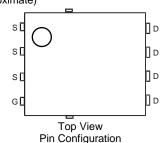
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)





PowerDI5060-8/SWP (Type UX)





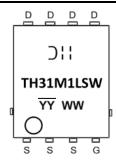
Ordering Information (Note 4)

Orderable Part Number	Paakaga	Packing		
Orderable Part Number	Package	Qty.	Carrier	
DMTH31M1LPSWQ-13	PowerDI5060-8/SWP (Type UX)	2500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



TH31M1LSW = Product Type Marking Code
YYWW or YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 24 = 2024)
WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	30	V	
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 7)	Tc = +25°C Tc = +70°C	l _D	130 111	А
Continuous Drain Current, V _{GS} = 10V (Note 6) $ T_{A} = +25^{\circ}C $ $ T_{A} = +70^{\circ}C $		lD	40 32	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)	I _{DM}	500	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	4.2	Α	
Pulsed Body Diode Forward Current (380µs Pulse, Duty Cycle = 1%)		I _{SM}	500	Α
Avalanche Current, L = 0.1mH (Note 8)		las	76	Α
Avalanche Energy, L = 0.1mH (Note 8)		Eas	296	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	1.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	70	°C/W
Total Power Dissipation (Note 6)		PD	3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	42	°C/W
Thermal Resistance, Junction to Case (Note 7)		R _θ JC	3.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

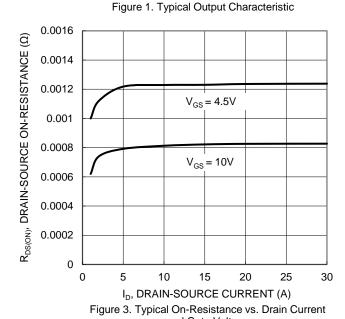
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BVDSS	30	_	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	ı	1	μΑ	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	Vgs(TH)	1.3		2.3	V	$V_{DS} = V_{GS}$, $I_{D} = 1mA$	
Static Drain-Source On-Resistance	D- avan	_	0.7	0.95	mΩ	$V_{GS} = 10V, I_{D} = 30A$	
Static Drain-Source On-Resistance	RDS(ON)	_	0.9	1.5	11122	$V_{GS} = 4.5V, I_D = 30A$	
Diode Forward Voltage	VsD	_	0.7	1.2	V	V _G S = 0V, I _S = 30A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	_	5938		рF	15 15 17 17 18 18 18 18 18 18 18 18 18 18 18 18 18	
Output Capacitance	Coss	_	4806	_	pF	$V_{DS} = 15V, V_{GS} = 0V,$ - f = 1MHz	
Reverse Transfer Capacitance	Crss	_	201	_	pF		
Gate Resistance	Rg	_	0.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Qg	_	86	_	nC		
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	39	_	nC	45)/ 1 004	
Gate-Source Charge	Qgs	_	13	_	nC	$V_{DS} = 15V, I_{D} = 30A$	
Gate-Drain Charge	Qgd	_	7	_	nC	1	
Turn-On Delay Time	t _D (ON)	_	12	_	ns		
Turn-On Rise Time	t _R	_	28	_	ns	V _{DD} = 15V, V _{GEN} = 10V,	
Turn-Off Delay Time	tD(OFF)	_	82	_	ns	$R_{GEN} = 4.7\Omega, I_D = 30A$	
Turn-Off Fall Time	tF		45		ns		

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.
- 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to product testing.



50.0 $t_{GS} = 3.5 \text{V}$ $V_{GS} = 3.0V$ 45.0 $V_{GS} = 4.0 V$ 40.0 $V_{GS} = 4.5V$ $V_{GS} = 5.0V$ ID, DRAIN CURRENT (A) 35.0 $V_{\rm GS} = 10.0 \rm V$ $V_{GS} = 2.8V$ 30.0 25.0 20.0 15.0 10.0 $V_{GS} = 2.5V$ 5.0 0.0 2 0 3 4 5 V_{DS}, DRAIN-SOURCE VOLTAGE (V)



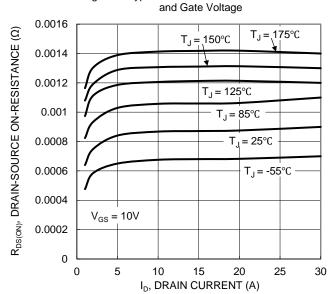


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

DMTH31M1LPSWQ

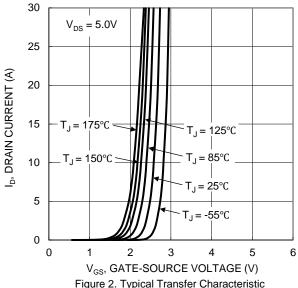
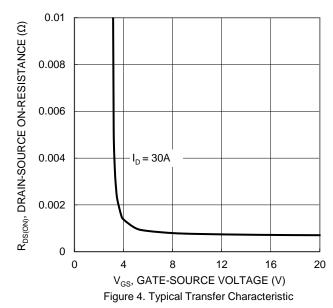


Figure 2. Typical Transfer Characteristic



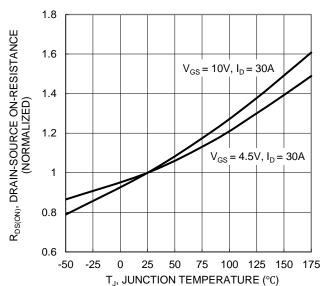


Figure 6. On-Resistance Variation with Junction Temperature





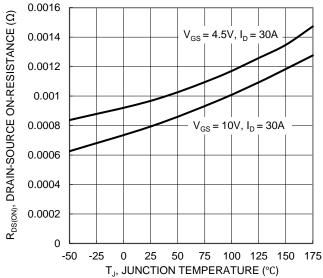


Figure 7. On-Resistance Variation with Junction Temperature

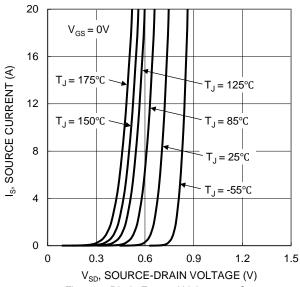


Figure 9. Diode Forward Voltage vs. Current

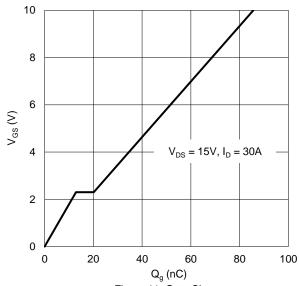


Figure 11. Gate Charge

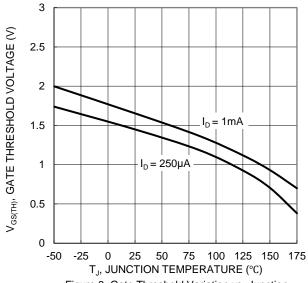
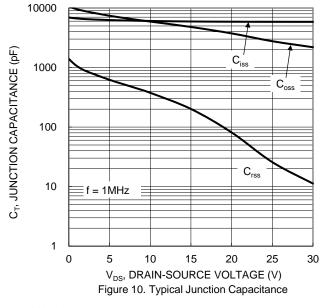
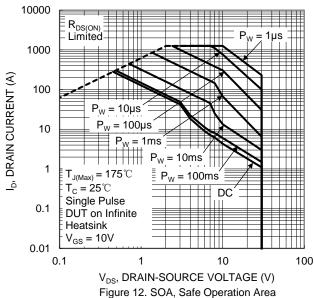


Figure 8. Gate Threshold Variation vs. Junction Temperature







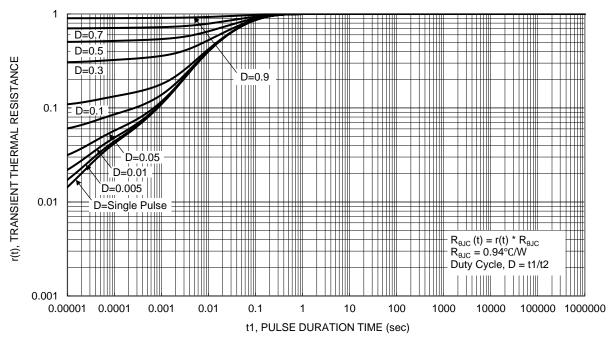


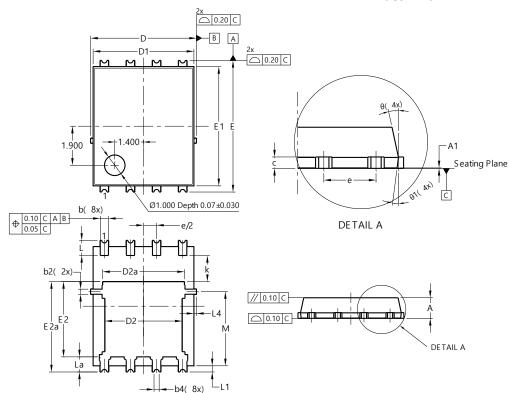
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)

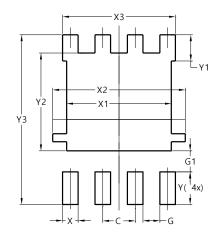


PowerDI5060-8/SWP				
(Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	-	
C	0.230	0.330	0.277	
D		.15 BS0)	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E	6	.40 BS0	2	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е		.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	5.190		
Х3	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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